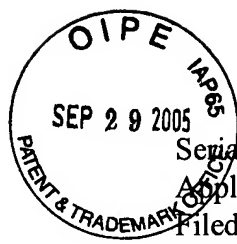


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 10/807,931
Applicant: Douglas James Tweet *et al.*
Filed: March 23, 2004
Group #: 2812
Examiner: Walter Lee Linsay, Jr.

Confirmation Number: 5155

Docket No: SLA.0586
Customer No: 55376
For: Method of Forming Local "Silicon-on-Nothing" or "Silicon-on-Insulator" Wafers
with Tensile-strained Silicon

MS AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

**RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. § 1.111
REQUEST FOR EXTENSION OF TIME IN WHICH TO RESPOND
Change of Correspondence Address
Introductory Comments**

In response to the Office Action dated June 9, 2005, please amend the above-identified Application as follows:

Amendment to the Specification None

Amendment to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendment to the Drawings begin on page 8 of this paper, and include an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 9 of this paper.

An **Appendix** including amended drawings figures is attached following page 11 of this paper.

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